

### Features

- 2.4 - 2.5GHz Frequency Range
- High Efficiency Optimized for Battery Operation
- Delivers up to +21dBm Output Power at 3.3V
- 85mA at +20dBm Output Power at 3.3V
- 2.5dB LNA Noise Figure
- 2.7 - 3.6V Operation
- Single-Ended Transceiver Interface
- -40°C to 125°C Extended Temperature Range
- 3mm x 3mm x 0.45mm 16-Pin QFN Package

### Applications

- IoT (Internet of Things), M2M Connectivity
- Mesh Network
- 802.15.4 Zigbee, RF4CE, Proprietary ISM
- Wi-Fi (low-data-rate use cases)
- Smart Home Hubs and Gateways
- Consumer Electronics, Smart Appliances
- Smart Lighting, Smart Light Fixture, Smart Metering
- Drone, Toy, Media Remote Controller
- Industrial Wireless Sensor Networks
- Home, Industrial, Factory Automation
- Wireless Sensor Nodes & Networks
- Wireless Audio & Video

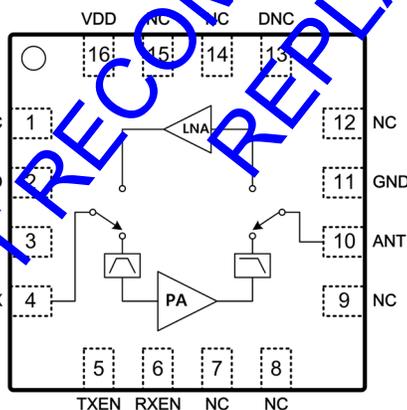


Figure 1: Functional Block Diagram

### Description

The 8TR8201 is a compact, multi-function Front-End RFIC (Radio Frequency Integrated Circuit) intended for 802.15.4 ZigBee™/ Thread and proprietary ISM wireless protocol systems in the 2.4GHz band.

The 8TR8201 is optimized for battery operation with enhanced efficiency, operating over a wide voltage supply range from 2.7V to 3.6V, suited for a wide array of applications including battery-powered wireless systems.

The 8TR8201 combines a transmit power amplifier (PA), receive low noise amplifier (LNA), a single pole, double throw (SPDT) transmit / receive (T/R) switch (Figure 1) in a 3mm x 3mm x 0.45mm 16-pin QFN package. It also comes integrated with filter networks and input/output matching circuitry. The device delivers up to +21dBm saturated output power at a supply voltage of 3.3V.

The 8TR8201 is RoHS compliant, halogen-free, and REACH compliant. It is rated for Moisture Sensitivity Level 1 (MSL1), reflow at 260°C per JEDEC J-STD-020. Refer to IPC/JEDEC J-STD-020 for detailed solder reflow temperature and profile.

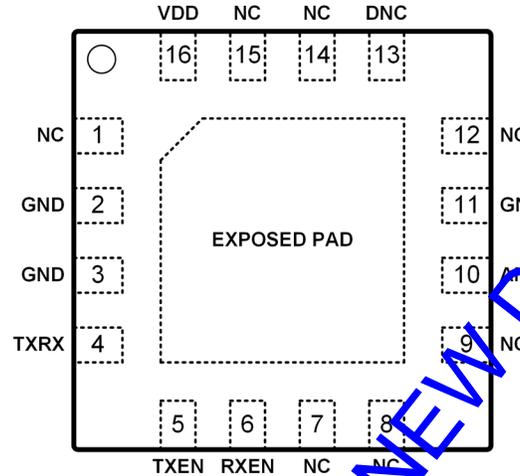


16-Lead 3mm x 3mm x 0.45mm, QFN Package

Figure 2: Package Type

### Ordering Information

Part Number	Description
8TR8201	2.4GHz Front-End RFIC 2500pieces per Tape and Reel
8TR8201-EVB	Fully Tested and Characterize Evaluation Board
8TR8201-DWF	2.4GHz Front-End RFIC Die in Wafer Form

**Pin Descriptions**

**Figure 3 :Pin Description (Top View)**
**Table 1: 8TR8201 Pin Signal Descriptions**

Pin	Name	Description	Pin	Name	Description
1	NC	Not connected internally	9	NC	Not connected internally
2	GND	Ground	10	ANT	Antenna Port (DC shorted to GND)
3	GND	Ground	11	GND	Ground
4	TXRX	Transmit/Receive Port (DC shorted to GND)	12	NC	Not connected internally
5	TXEN	Control Logic Pin	13	DNC	Do Not Connect
6	RXEN	Control Logic Pin	14	NC	Not connected internally
7	NC	Not connected internally	15	NC	Not connected internally
8	NC	Not connected internally	16	VDD	DC Voltage Supply
EXPOSED PAD		Exposed pad should be connected to GND.			

**General Specifications**
**Table 2: 8TR8201 Absolute Maximum Ratings**

Parameter	Units	Minimum	Maximum
Supply Voltage (VDD)	V	0	3.7
Control Logic Pin (TXEN, RXEN)	V	0	VDD
Transmit Output Power at ANT Port	dBm		23
Transmit Input Power at TXRX Port	dBm		10
Receive Input power at ANT Port	dBm		5
Storage Temperature	°C	-40	150

Note: Sustained operation at or above the Absolute Maximum Ratings for any single or combinations of the parameters above may result in permanent damage to the device and is not recommended. All Maximum RF Input Power Ratings assume 50Ω terminal impedance.

**Table 3: 8TR8201 Recommended Operating Conditions**

Parameter	Units	Minimum	Typical	Maximum
Supply Voltage (VDD, recommended)	V	2.7	3.3	3.6
Supply Voltage (VDD, extend supply voltage)**	V	1.8		3.6
Control Pin - Logic High State (TXEN, RXEN)		1.2		VDD*
Control Pin - Logic Low State (TXEN, RXEN)		0		0.4
Operating Frequency Range	GHz	2.4		2.5
Operating Temperature	°C	-40	25	125

\*For Control Voltages > 3.0V, a 10kΩ series resistor should be used at the Control Logic Pins.

\*\*Functional working with degraded performance for the supply voltage range 1.8V to 2.7V.

**Table 4: 8TR8201 Transmit Electrical Specifications**

(VDD = 3.3V, T<sub>Ambient</sub> = 25°C, With External Harmonic Filter, Excluding PCB and Connector Loss, Unless Otherwise Noted)

Parameter	Units	Min	Typ	Max	Test Conditions
Frequency Range	GHz	2.4		2.5	
Saturated Output Power	dBm		21		
Large-Signal Gain	dB		24		+20dBm Pout
Current Consumption	mA		85		+20dBm Pout
			100		+21dBm Pout
Tx Quiescent Current	mA		15		No RF applied
Second Harmonic	dBm/MHz		-50		Up to +21dBm with Harmonic Filter as specified
Third Harmonic	dBm/MHz		-50		
Input Return Loss	dB		-10		
Load VSWR for Stability			6:1		All Non-harmonic Spurs Less than -43dBm/MHz Up to +21dBm
Load VSWR for Ruggedness			10:1		No Damage

**Table 5: 8TR8201 Receive Electrical Specifications**

(VDD = 3.3V, T<sub>Ambient</sub> = 25°C, With External Harmonic Filter, Excluding PCB and Connector Loss, Unless Otherwise Noted)

Parameter	Units	Min	Typ	Max	Test Conditions
Frequency Range	GHz	2.4		2.5	
Small-Signal Gain	dB		12		
Current Consumption	mA		8		
Noise Figure	dB		2.5		
Input P1dB	dBm		-8		
Input IP3	dBm		0		
Input Return Loss	dB		-8		
Output Return Loss	dB		-8		

**Table 6: 8TR8201 Shutdown Mode Specifications**

(VDD = 3.3V, T<sub>Ambient</sub> = 25°C, With External Harmonic Filter, Excluding PCB and Connector Loss, Unless Otherwise Noted)

Parameter	Units	Min	Typ	Max	Test Conditions
Shutdown Current	uA		0.3	1	
Shutdown Mode ANT-TXRX Isolation	dB		23		

**Table 7: 8TR8201 Switching Time Specifications**

(VDD = 3.3V, T<sub>Ambient</sub> = 25°C, With External Harmonic Filter, Unless Otherwise Noted)

Parameter	Units	Min	Typ	Max	Test Conditions
TX to RX	usec		0.7		From 50% of RXEN to 90% of RX power
TX to Shutdown	usec		0.25		From 50% of TXEN to 10% RF
RX to TX	usec		0.3		From 50% of TXEN to 90% RF
RX to Shutdown	usec		0.15		From 50% of RXEN to 10% RF
Shutdown to TX	usec		0.5		From 50% of TXEN to 90% RF
Shutdown to RX	usec		0.85		From 50% of RXEN to 90% RF

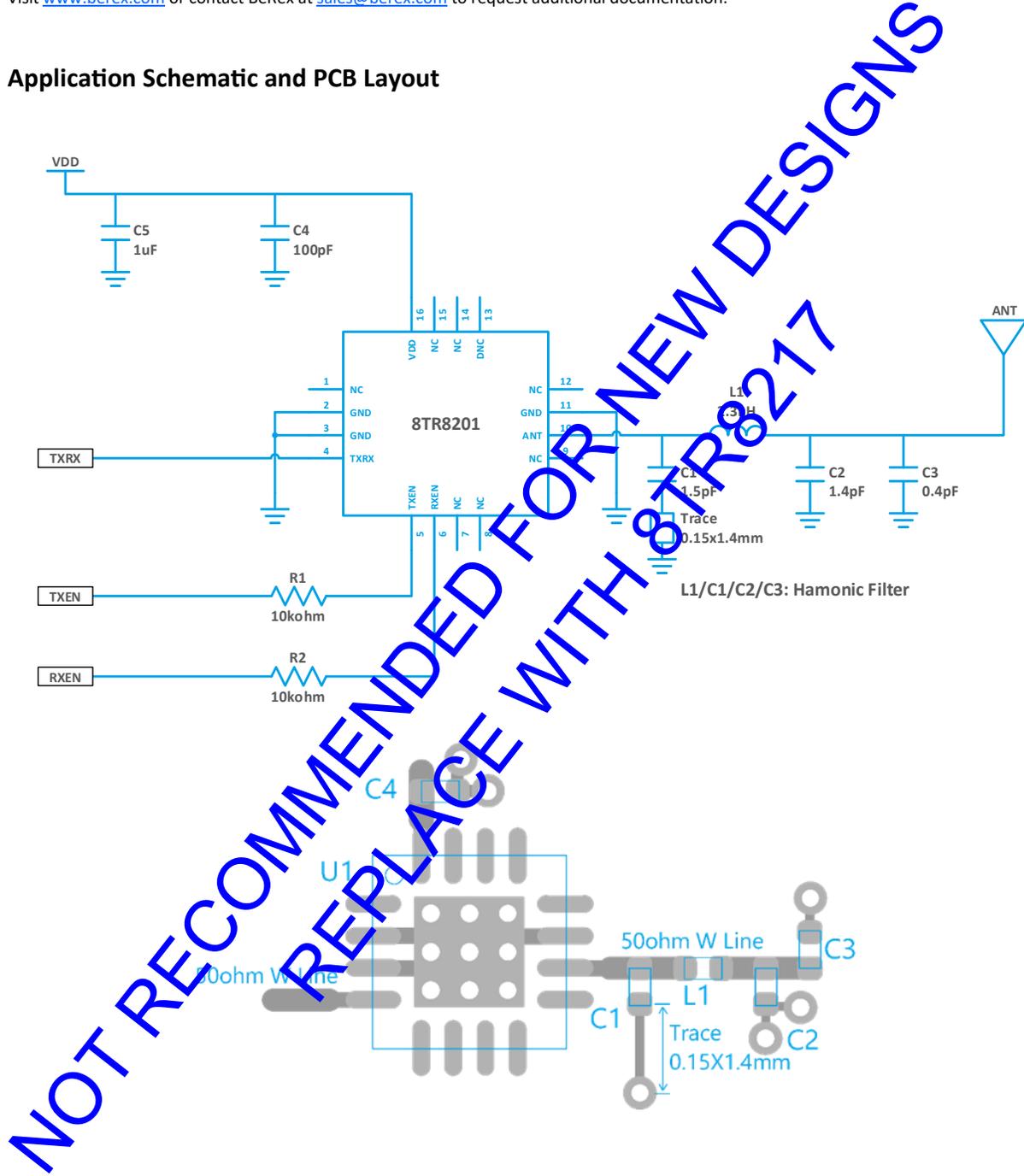
**Table 8: 8TR8201 Control Logic**

"1" = Logic High, "0" = Logic Low

TXEN	RXEN	Operational Mode
0	0	Shutdown Mode
0	1	RX Mode
1	0	TX Mode
1	1	TX Mode

**Application Notes**

The 8TR8201 Application note provides detailed descriptions and test data over various operating conditions. Visit [www.berex.com](http://www.berex.com) or contact BeRex at [sales@berex.com](mailto:sales@berex.com) to request additional documentation.

**Application Schematic and PCB Layout**


**Figure 4: 8TR8201 Reference Design Schematic and PCB Layout**

### Package Dimensions

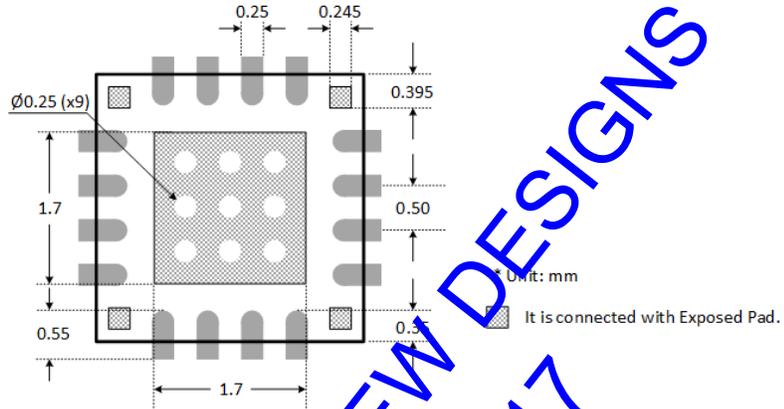
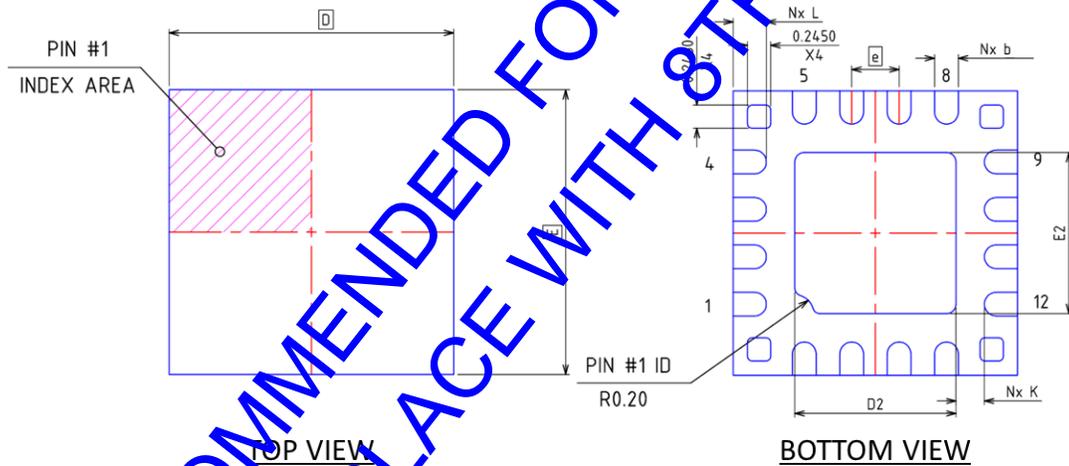
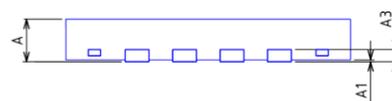


Figure 5: 8TR8201 Recommended PCB Layout Footprint



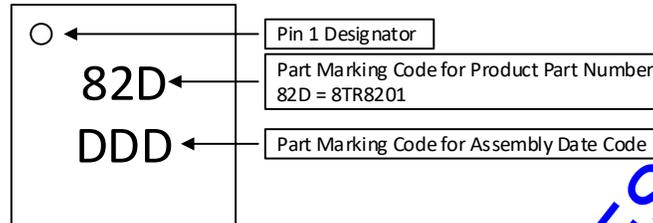
	MIN.	NOM.	MAX.
A	0.21	0.45	0.50
A1	0.05	0.02	0.05
A3	---	0.127 Ref	---
b	0.18	0.25	0.30
D	3.00 BSC		
E	3.00 BSC		
e	0.50 BSC		
D2	1.55	1.70	1.80
E2	1.55	1.70	1.80
K	0.20	---	---
L	0.25	0.35	0.45
N	16		



SIDE VIEW

Figure 6: 8TR8201 Package Dimension

## Package Marking



Note: The part marking: 82D represents the Product Part Number: 8TR8201.

Due to the size limitations of this package, only three (3) characters can be marked on each of two (2) rows. Therefore the Product Part Number is represented in the part marking by a 3-character code.

Figure 7: 8TR8201 Typical Part Marking

## ESD Handling Information

Electro Static Discharge (ESD) can cause immediate (or latent) failures in semiconductor Integrated Circuits (ICs). BeRex, Inc. RFIC products are designed with integral ESD protection structures, and all IC products are tested to meet industry standards for ESD event survival. Users must adhere to all precautions for handling ESD sensitive devices throughout the manufacturing, test, shipping, handling, or operational processes, and during field service operations in order to achieve optimum system performance and life expectancy. Production quantities of this product are shipped in a standard tape and reel format.

## RoHS Compliance



This part is compliant with Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This part is lead-free, halogen-free and complies with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1% (w/w) in each component of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

### Tape & Reel

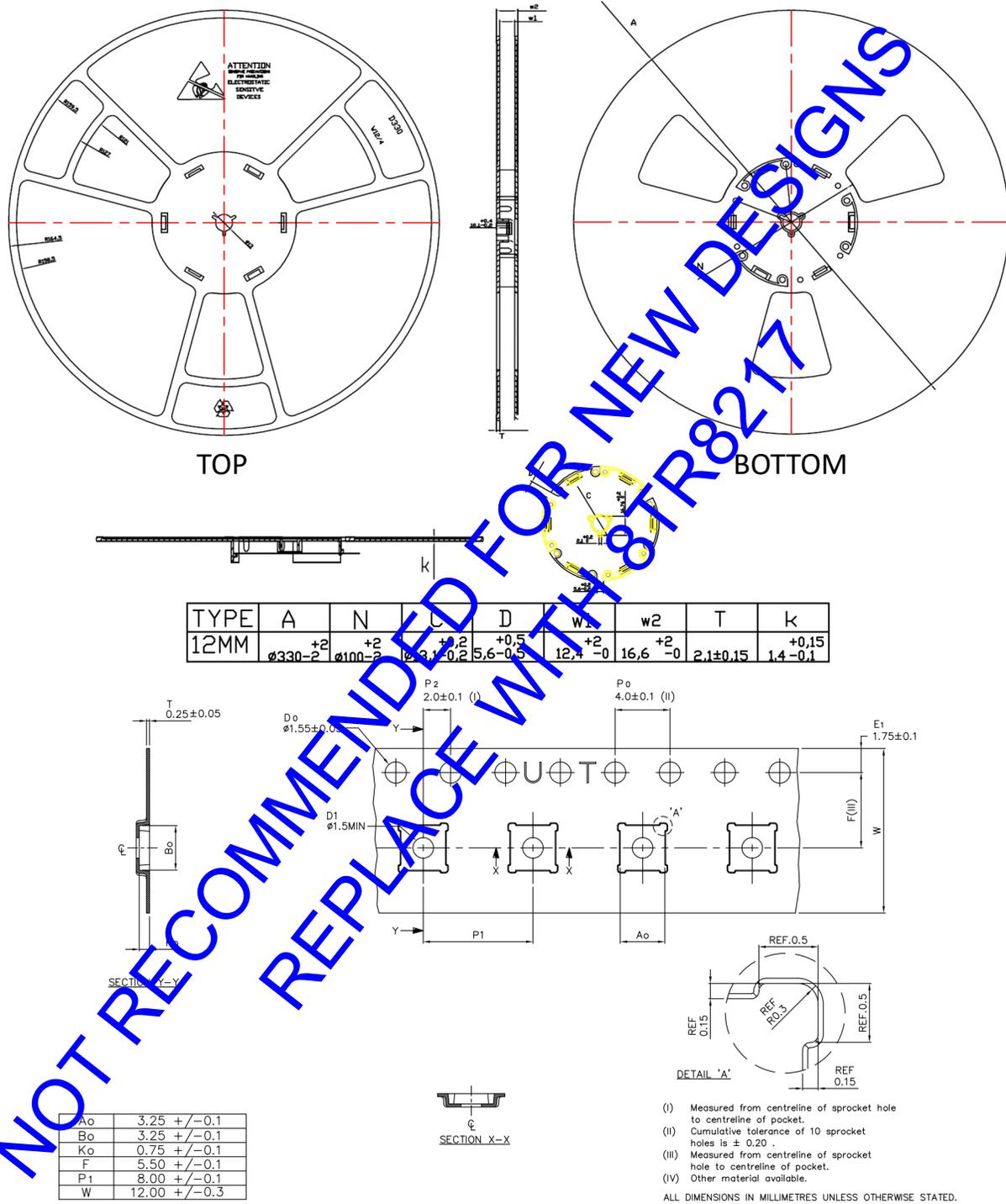


Figure 8: 8TR8201 Tape and Reel Dimension